

## **Preliminary Exhibitor list A to Z (as of July 16, 2024)**

- **3-D MID e.V. Research Association Mechatronic Integrated Devices (DE)**
- **ABeetle Corp. (TW)**
- **Ames Advanced Materials Corp. (US)**
- **AMIRES s.r.o. (CZ)**
- **BST GmbH (DE)**
- **CCI Eurolam GmbH (DE)**
- **Celanese Performance Solutions Germany GmbH (DE)**
- **CeNTI-Centre for Nanotechnology and Smart Materials (PT)**
- **Coatema Coating Machinery GmbH (DE)**
- **CondAlign AS (NO)**
- **COVEME s.p.a. (IT)**
- **Covestro Deutschland AG (DE)**
- **db-matik AG (DE)**
- **DELO Industrie-Klebstoffe GmbH & Co. KG aG (DE)**
- **DICO Electronic GmbH (DE)**
- **DoMicro BV (NL)**
- **Dongguan Yuanguan Technology (CN)**
- **E INK Holdings Inc. (US)**
- **ELANTAS Europe GmbH (DE)**

- **Epishine AB** (SE)
- **Excelitas Technologies GmbH & Co. KG** (DE)
- **FLEXOO GmbH** (DE)
- **Foehrenbach Application Tooling NV** (BE)
- **Franz Binder GmbH & Co. Elektrische Bauelemente KG** (DE)
- **Fraunhofer-Institut IFAM** (DE)
- **GM Grafisk Maskinfabrik A/S** (DK)
- **Grünig-Interscreen AG** (CH)
- **Hamamatsu Photonics Deutschland GmbH** (DE)
- **Henkel AG & Co. KGaA** (DE)
- **Heraeus Epurio GmbH** (DE)
- **Hummink** (FR)
- **HX Production Group Limited** (HK)
- **IEE S.A.** (LU)
- **INM - Leibniz-Institut für Neue Materialien gGmbH** (DE)
- **Ino, d.o.o., Žiri** (SI)
- **KETMarket GmbH** (DE)
- **Kimoto LTD** (CH)
- **MicroCraft K.K.** (JP)

- **Nagase ChemteX America Corp.** (US)
- **Nanoinitiative Bayern GmbH** (DE)
- **NanoSen GmbH** (De)
- **Niebling GmbH** (DE)
- **Notion Systems GmbH** (DE)
- **nsm Norbert Schlaefli AG** (CH)
- **OE-A (Organic and Printed Electronics Association)** (DE)
- **OES - Organic Electronics Saxony Management GmbH** (DE)
- **Panacol-Elosol GmbH** (DE)
- **PVF Mesh Screen Technology GmbH** (DE)
- **RK Siebdrucktechnik GmbH** (DE)
- **Roos GmbH** (DE)
- **Saralon GmbH** (DE)
- **SAT Electronic GmbH** (DE)
- **SEFAR AG** (CH)
- **Seristampa Srl** (IT)
- **ShenZhen Hochuen Technologies Co., Ltd.** (CN)
- **Shenzen Nuobeier Technology Development Co., Ltd** (CN)
- **SpeedPox GmbH** (AT)

- **SignTronic AG** (CH)
- **SPGPrints B.V.** (NL)
- **Sun Chemical Ltd** (GB)
- **Teca-Print AG** (CH)
- **Technic Inc.** (US)
- **THIEME GmbH & Co. KG** (DE)
- **TNO at Holst Centre** (NL)
- **VDL Enabling Technologies Group** (NL)
- **Witte Technology GmbH** (DE)
- **XTPL S.A.** (PL)